



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



## Contact us

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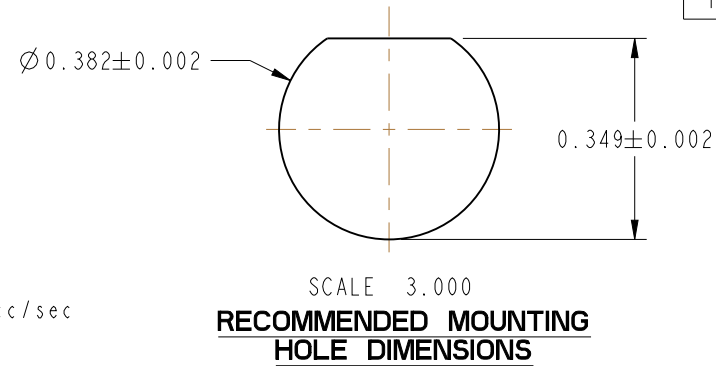
1. MATERIALS AND FINISHES:  
BODY - BRASS, SILVER PLATING  
CONTACT - BeCu, GOLD PLATING  
INSULATOR - PTFE  
GLASS SEAL : KOVAR STEEL, GOLD PLATING


2. ELECTRICAL:  
A. IMPEDANCE: 50 OHM  
B. DIELECTRIC WITHSTANDING VOLTAGE : 1500 VRMS

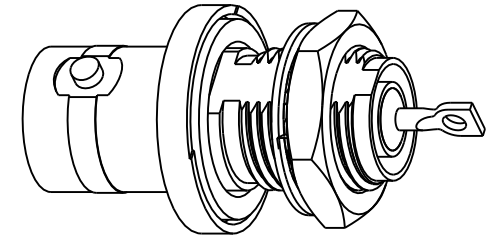
3. MECHANICAL:

- A. DURABILITY: 500 CYCLES MIN.
- B. TEMPERATURE RANGE : -65°C TO +165°C
- C. SOLDER JOINT MUST WITHSTAND A LEAKAGE RATE OF  $1 \times 10^{-5}$  cc/sec OF TRACER GAS AT ATMOSPHERIC PRESSURE.

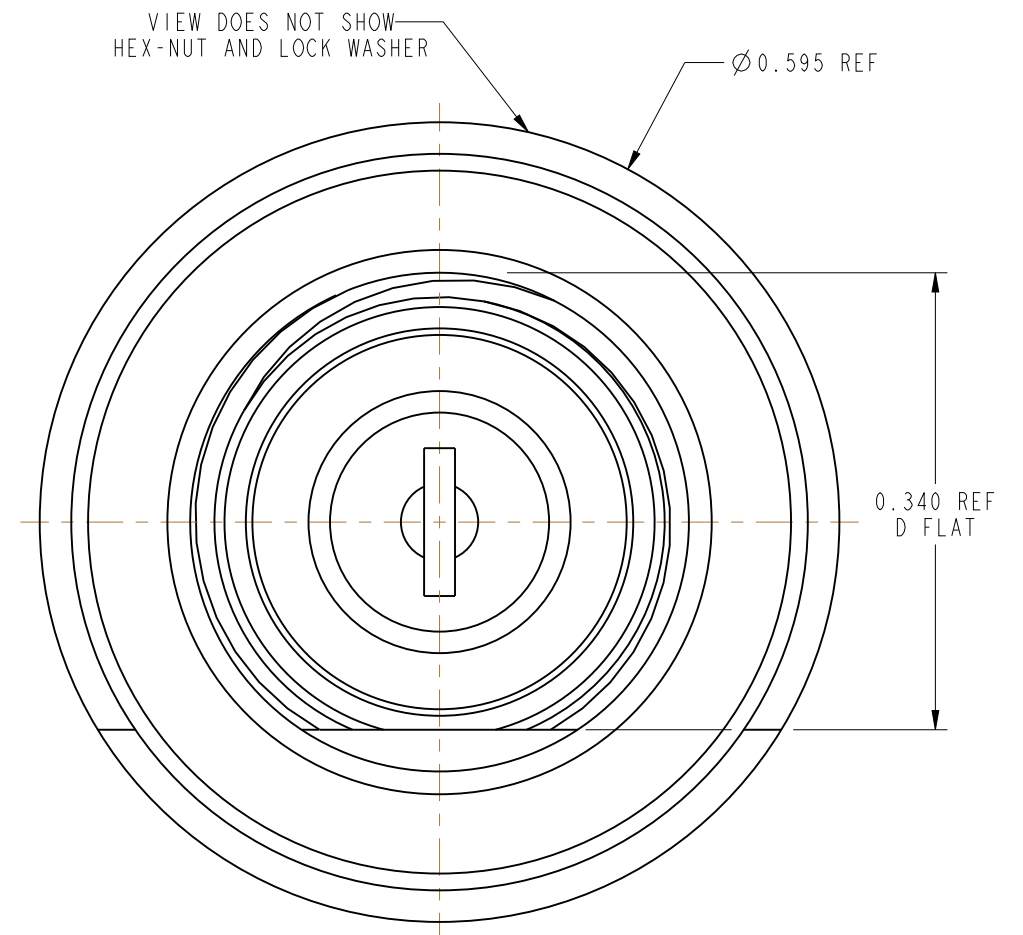
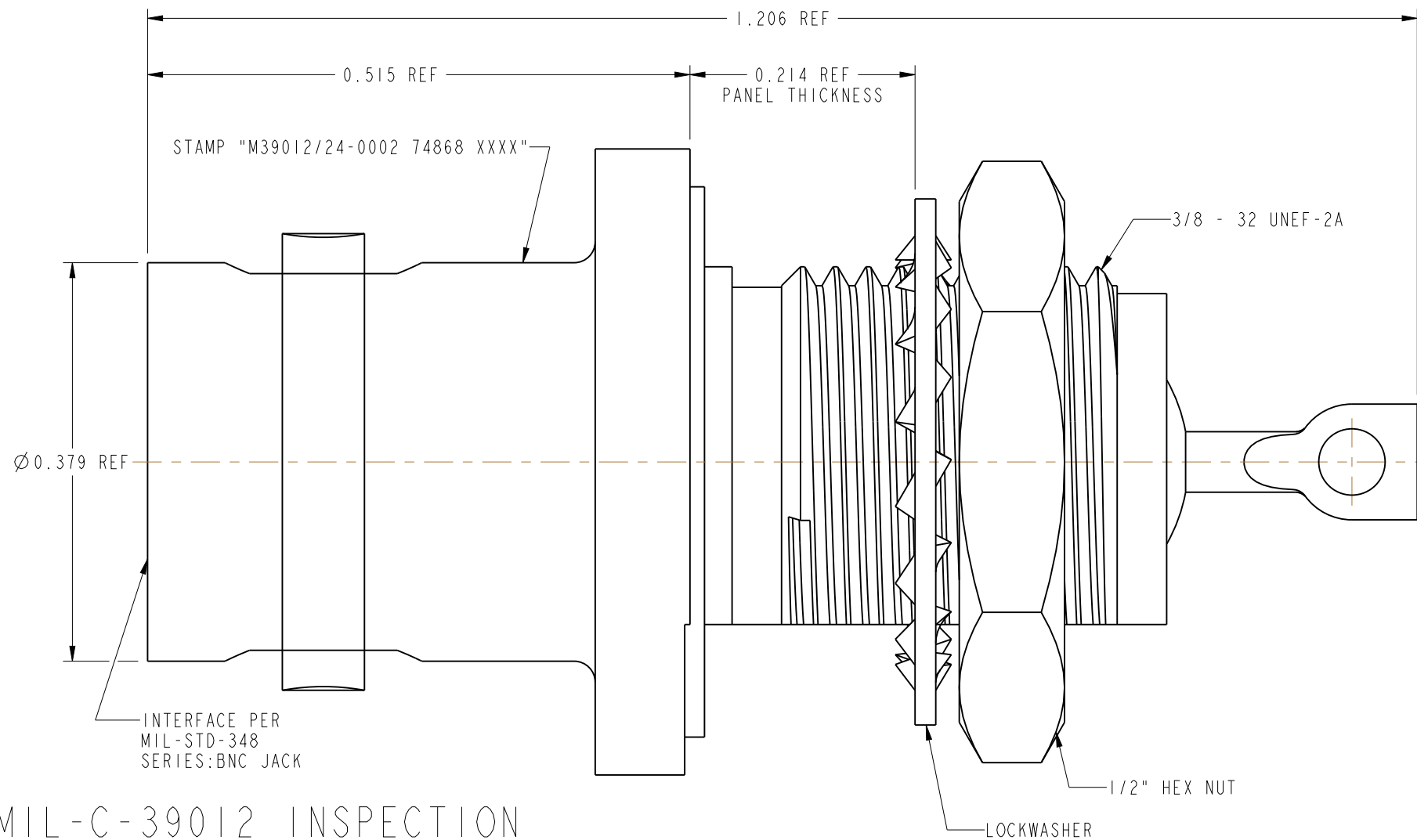
4. PACKAGING:  
A. QUANTITY: SINGLE PACK  
B. MARKING: BAG TO BE MARKED  
"AMPHENOLRF, 31-4238, AND DATE CODE"



31-4238		REVISIONS				
DRAWING NO.		REV	DESCRIPTION	DATE	ECO	APPR
THIRD ANGLE PROJ. 		A	OFFICIAL ENG. RELEASE TO MFG.	7/31/70	17637	
002		S	SEE SHEET I	9/22/99	43115	CPM
		T	SEE SHEET I	6/29/06	46131	CPM
		U	SEE SHEET I	3/13/12	48970	RAK
		V	3/8-32UNEF-2A WAS 5/16-32UNEF-2A; 1/2" HEX NUT WAS 0.495 HEX NUT	6/7/12	49058	RAK



SCALE 2.000



MIL-C-39012 INSPECTION

# CUSTOMER OUTLINE DRAWING

ALL OTHER SHEETS ARE FOR INTERNAL USE ONLY

UNLESS OTHERWISE SPECIFIED, DIMENSIONS ARE IN INCHES AND TOLERANCES ARE: 2 PLACE DECIMAL      3 PLACE DECIMAL      ANGLES ±.015 (0,381 mm)      ±.005 (0,127 mm)      ± 1°	MATERIAL  SEE NOTES	DRAWN ABHAYA KISHORE	DATE 23-Feb-12	TITLE  TYPE BNC FRONT MOUNT HERMETIC RECEPTACLE			Amphenol RF Danbury, CT, USA Tainan, Taiwan Shenzhen, China www.amphenolrf.com		
ENGINEER T. AUBIN		DATE 08-Sep-99							
APPROVED		DATE							
NOTICE - These drawings, specifications, or other data (1) are, and remain the property of Amphenol Corp. (2) must be returned upon request; and (3) are confidential and not to be disclosed to any person other than those to whom they are given by Amphenol Corp. The furnishing of these drawings, specifications, or other data by Amphenol Corp., or to any other person to anyone for any purpose is not to be regarded by implication or otherwise in any manner licensing, granting rights or permitting such holder or any other person to manufacture, use or sell any product, process or design, patented or otherwise, that may in any way be related to or disclosed by said drawings, specifications, or other data.		REFERENCE MIL-C-39012/24-0002 EPA 802206-51 GEN# ASSYF10-BNC	CAD FILE	CODE ID 74868	DWG SIZE B	DRAWING NO. 31-4238	REV V		